<u>Spec. No. JENF243A-0003AJ-01</u> P.1/12

Chip Ferrite Bead BLM18□□□□□□N1□ Reference Specification

1.Scope

This reference specification applies to Chip Ferrite Bead BLM18_□N Series.

2.Part Numbering

(ex.) <u>BL M 18 AG 121 S N 1 D</u> (1) (2) (3) (4) (5) (6) (7) (8) (9)

(1)Product ID (2)Type (3)Dimension(L×W) (4)Characteristics (5)Typical Impedance at 100MHz

(6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

3.Rating

			1				1															
MURATA					ndition) (mA) Values			Remark														
Part Number	resuing C				Initial		Remark															
		Typical	al 85°C 125°C		Values																	
BLM18RK121SN1D	100.050/				0.05																	
BLM18RK121SN1B	120±25%	120	20)()	0.25	0.35																
BLM18RK221SN1D	220+250/	220	20	20	0.00	0.40																
BLM18RK221SN1B	220±25%	220	20)0	0.30	0.40	_															
BLM18RK471SN1D	470+250/	470	20	20	0.50	0.60	For Digital															
BLM18RK471SN1B	470±25%	470	20)0	0.50	0.60	Interface															
BLM18RK601SN1D	600+25%	600	20	00	0.60	0.70	IIILEITACE															
BLM18RK601SN1B	000±2376	000	20	<i></i>	0.00	0.70																
BLM18RK102SN1D	1000+25%	1000	20	00	0.80	0.00																
BLM18RK102SN1B	1000±2370	1000	20		0.00	0.90																
BLM18PG300SN1D	20 min	20	10	00	0.05	0.10																
BLM18PG300SN1B	20 111111.	30	10		0.03	0.10																
	33+25%	33	3000*1	1000*1	0.025	0.050																
	JJ12J 70	33	0000	1000	0.023	0.000																
	40 min	60	1000		0.1	0.2																
	40 111111.	00	10	1		0.2																
	120+25%	120	2000*1	1000*1	0.05	0.10																
		0			0.00	00																
	180±25%	180	1500*1	1000*1	0.09	0.18																
						-																
	220±25%	220	1400*1	1000*1	0.10	0.14	For DC															
	330±25%	330	1200*1	1000*1	0.15	0.20																
							power line															
	470±25%	470	10	00	0.20	0.26																
	30±10	30	6000*1	4000*1	0.008	0.010																
						1																
	100±25%	100	3700*1	2500*1	0.022	0.026																
BLM18SP221SN1D	220+25%	220	2800*1	1900*1	0.040	0.048																
BLM18SP221SN1B	220:20/0	220	2000	1000	0.040	0.040																
BLM18SP601SN1D	600+250/	600	1500*1	1000*1	0.140	0.169																
BLM18SP601SN1B	000±25%	600	600	600	600	600	600	600	600	600	600	600	600	600	600	600	600	1300	1000	0.140	0.100	
BLM18SP102SN1D	4000.0504		4000#4	000*1	0.40=	0.000																
BLM18SP102SN1B	1000±25%	1000	1200*1	800*1	0.185	0.222																
	BLM18RK121SN1D BLM18RK221SN1D BLM18RK221SN1D BLM18RK221SN1D BLM18RK421SN1B BLM18RK471SN1D BLM18RK471SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK102SN1D BLM18RK102SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG310SN1D BLM18PG310SN1D BLM18PG310SN1D BLM18PG310SN1D BLM18PG31SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG181SN1D BLM18PG221SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG471SN1D BLM18SP300SN1D BLM18SP101SN1D BLM18SP101SN1D BLM18SP101SN1D BLM18SP221SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D	MURATA Part Number (at 100MHz, Under St Testing Contents) BLM18RK121SN1D BLM18RK221SN1D BLM18RK221SN1D BLM18RK471SN1D BLM18RK471SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK102SN1D BLM18RK102SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG30SN1D BLM18PG30SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG221SN1D BLM18PG221SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18PG471SN1D BLM18SP300SN1D BLM18SP300SN1D BLM18SP300SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP221SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP601SN1D BLM18SP102SN1D BLM18SP102SN1D BLM18SP102SN1D BLM18SP102SN1D BLM18SP601SN1B BLM18SP601SN1D BLM18SP601SN1B BLM18SP601SN1B BLM18SP102SN1D BLM18SP10	Part Number	MURATA Part Number (at 100MHz, Under Standard Testing Condition) Current (m BLM18RK121SN1D BLM18RK221SN1D BLM18RK221SN1D BLM18RK221SN1D BLM18RK471SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK102SN1D BLM18RK102SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG300SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG331SN1D BLM18PG31SN1D BLM18	MURATA Part Number (at 100MHz, Under Standard Testing Condition) Current (mA) BLM18RK121SN1D BLM18RK221SN1B BLM18RK221SN1B BLM18RK221SN1D BLM18RK221SN1B BLM18RK221SN1B BLM18RK471SN1D BLM18RK471SN1D BLM18RK471SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK601SN1D BLM18RK601SN1B BLM18RK102SN1D BLM18RK102SN1D BLM18PG300SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG600SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG121SN1D BLM18PG31SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG331SN1D BLM18PG371SN1D BLM18PG371SN1B BLM18PG371SN1D	MURATA Part Number Murath Part Number Murath Part Number Testing Condition Typical at 85°C 125°C Initial Values Murath Part Number Typical at 85°C 125°C Initial Values Murath Part Number Murath Part Number Typical at 85°C 125°C Murath Part Number Murath Part Num	MURATA Part Number Murating Condition Typical at 85°C 125°C Mules Part Number Mules Part Number Testing Murating Part Number Mules Part Number															

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Customer	MURATA	Impedance (Ω) (at 100MHz, Under Standard Testing Condition)		Rated Current (mA)		DC Resistance (Ω max.)		Damanik
Part Number	Part Number	resting C	Typical	at 85°C	at 125°C	Initial Values	Values After Testing	Remark
	BLM18KG221SN1D BLM18KG221SN1B	220±25%	220	2200*1	1500*1	0.050	0.060	
	BLM18KG331SN1D BLM18KG331SN1B	330±25%	330	1700*1	1200*1	0.080	0.095	
	BLM18KG471SN1D BLM18KG471SN1B	470±25%	470	1500*1	1000*1	0.130	0.145	
	BLM18KG601SN1D BLM18KG601SN1B	600±25%	600	1300*1	1000*1	0.150	0.165	For DC power line
	BLM18KG102SN1D BLM18KG102SN1B	1000±25%	1000	1000*1	800 ^{*1}	0.200	0.230	power line
	BLM18SD220SN1D	22±25%	22	6000 ^{*1}	3500 ^{*1}	0.008	0.013	
	BLM18SD220SN1B BLM18SG330SN1D	33±25%	33	6000*1	3500 ^{*1}	0.008	0.013	
	BLM18SG330SN1B BLM18AG121SN1D	120±25%	120	80		0.18	0.28	
	BLM18AG121SN1B BLM18AG151SN1D	150±25%	150	70		0.16	0.25	
	BLM18AG151SN1B BLM18AG221SN1D							
	BLM18AG221SN1B BLM18AG331SN1D	220±25%	220	70		0.25	0.35	For
	BLM18AG331SN1B BLM18AG471SN1D	330±25%	330	60		0.30	0.40	general use
	BLM18AG471SN1B BLM18AG601SN1D	470±25%	470	550 500		0.35	0.45	
	BLM18AG601SN1B BLM18AG102SN1D	600±25%	600			0.38	0.48	
	BLM18AG102SN1B	1000±25%	1000	45	50	0.50	0.60	
	BLM18BB050SN1D BLM18BB050SN1B	5±25%	5	80	00	0.05	0.10	
	BLM18BA050SN1D BLM18BA050SN1B	5±25%	5	50	00	0.2	0.3	
	BLM18BB100SN1D BLM18BB100SN1B	10±25%	10	70	00	0.10	0.20	
	BLM18BA100SN1D BLM18BA100SN1B	10±25%	10	50	00	0.25	0.35	
	BLM18BB220SN1D BLM18BB220SN1B	22±25%	22	70	00	0.20	0.30	
	BLM18BA220SN1D BLM18BA220SN1B	22±25%	22	50	00	0.35	0.45	For
	BLM18BB470SN1D BLM18BB470SN1B	47±25%	47	60	00	0.25	0.35	high speed signal line
	BLM18BD470SN1D BLM18BD470SN1B	47±25%	47	50	00	0.3	0.4	
	BLM18BA470SN1D BLM18BA470SN1B	47±25%	47	30	00	0.55	0.65	
	BLM18BB600SN1D	60±25%	60	600		0.25	0.35	
	BLM18BB600SN1B BLM18BA750SN1D	75±25%	75	30	00	0.70	0.80	
	BLM18BA750SN1B BLM18BB750SN1D BLM18BB750SN1B	75±25%	75	60	00	0.30	0.40	

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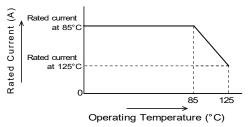
Customer	MURATA	Impedance (Ω) (at 100MHz, Under Standard Testing Condition)		Rated Current (mA)		(Ω r	sistance nax.) Values	Remark
Part Number	Part Number	C	Typical	at 85°C	at 125°C	Initial Values	After Testing	
	BLM18BB121SN1D BLM18BB121SN1B	120±25%	120	55	50	0.30	0.40	
	BLM18BD121SN1D BLM18BD121SN1B	120±25%	120	30	00	0.4	0.5	
	BLM18BA121SN1D BLM18BA121SN1B	120±25%	120	20	00	0.9	1.0	
	BLM18BB141SN1D BLM18BB141SN1B	140±25%	140	50	00	0.35	0.45	
	BLM18BB151SN1D BLM18BB151SN1B	150±25%	150	45	50	0.37	0.47	
	BLM18BD151SN1D BLM18BD151SN1B	150±25%	150	30	00	0.4	0.5	
	BLM18BB221SN1D BLM18BB221SN1B	220±25%	220	45	50	0.45	0.55	
	BLM18BD221SN1D BLM18BD221SN1B	220±25%	220	25	50	0.45	0.55	
	BLM18BB331SN1D BLM18BB331SN1B	330±25%	330	40	00	0.58	0.68	For
	BLM18BD331SN1D BLM18BD331SN1B	330±25%	330	25	50	0.5	0.6	high speed signal line
	BLM18BD421SN1D BLM18BD421SN1B	420±25%	420	250 300 250		0.55	0.65	
	BLM18BB471SN1D BLM18BB471SN1B	470±25%	470			0.85	0.95	
	BLM18BD471SN1D BLM18BD471SN1B	470±25%	470			0.55	0.65	
	BLM18BD601SN1D BLM18BD601SN1B	600±25%	600	200		0.65	0.75	
	BLM18BD102SN1D BLM18BD102SN1B	1000±25%	1000	200		0.85	0.95	
	BLM18BD152SN1D BLM18BD152SN1B	1500±25%	1500	15	50	1.2	1.3	
	BLM18BD182SN1D BLM18BD182SN1B	1800±25%	1800	15	50	1.5	1.6	
	BLM18BD222SN1D BLM18BD222SN1B	2200±25%	2200	15	50	1.5	1.6	
	BLM18BD252SN1D BLM18BD252SN1B	2500±25%	2500	150		1.5	1.6	
	BLM18TG121TN1D BLM18TG121TN1B	120±25%	120	20	00	0.25	0.3	
	BLM18TG221TN1D BLM18TG221TN1B	220±25%	220	20	00	0.3	0.4	For general
	BLM18TG601TN1D BLM18TG601TN1B	600±25%	600	200		0.45	0.6	use (Thin type)
	BLM18TG102TN1D BLM18TG102TN1B	1000±25%	1000			0.6	0.8	, ,,
	BLM18SG260TN1D BLM18SG260TN1B	26±25%	26	6000*1	1000*1	0.007	0.012	
	BLM18SG700TN1D BLM18SG700TN1B	70±25%	70	4000*1	1000*1	0.020	0.030	For DC power line
	BLM18SG121TN1D BLM18SG121TN1B	120±25%	120	3000*1	1000*1	0.025	0.035	(Thin type)

Customer Part Number	MURATA Part Number	LIVNICAL		at at			sistance max.) Values After Testing	Remark
	BLM18SG221TN1D BLM18SG221TN1B	220±25%	220	2500*1	1000*1	0.040	0.055	
	BLM18SG331TN1D BLM18SG331TN1B	330±25%	330	1500*1	1000*1	0.070	0.085	
	BLM18SN220TN1D BLM18SN220TN1B	22±7	22	8000*1	5000*1	0.004	0.005	
	BLM18KG260TN1D BLM18KG260TN1B	26±25%	26	6000*1	4000*1	0.007	0.012	For DC
	BLM18KG300TN1D BLM18KG300TN1B	30±25%	30	5000*1	3300*1	0.010	0.015	power line (Thin type)
	BLM18KG700TN1D BLM18KG700TN1B	70±25%	70	3500*1	2200*1	0.022	0.032	
	BLM18KG101TN1D BLM18KG101TN1B	100±25%	100	3000*1	1900*1	0.030	0.040	
	BLM18KG121TN1D BLM18KG121TN1B	120±25%	120	3000*1	1900*1	0.030	0.040	

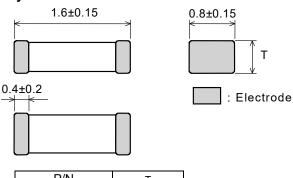
• Operating Temperature : -55°C to +125°C

• Storage Temperature : -55°C to +125°C

(*1)In case of Rated current is more than 1A, Rated Current is derated as right figure depending on the operating temperature.

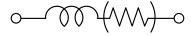


4. Style and Dimensions



P/N	Т	
BLM18SG***TN1*	0.5±0.15	
BLM18SN***TN1*	0.6±0.15	
BLM18TG***TN1*	0.6±0.1	
BLM18KG***TN1*	0.6±0.15	
BLM18*****SN1*	0.8±0.15	(in mm)

■ Equivalent Circuit



Resistance element becomes dominant at high frequencies.

■ Unit Mass (Typical value) BLM18*****SN1*:0.005g BLM18*****TN1*:0.004g

5.Marking

No marking.

6.Standard Testing Conditions

< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C) Humidity : Ordinary Humidity (25%(RH) to 85%(RH)) < In case of doubt >

Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH)

Atmospheric pressure: 86kPa to 106kPa

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7.Specifications 7-1.Electrical Performance

No.	Item	Specification	Test Method
7-1-1	Impedance	Meet item 3.	Measuring Frequency : 100MHz±1MHz Measuring Equipment : KEYSIGHT 4991A or the equivalent Test Fixture : KEYSIGHT 16192A or the equivalent
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment: Digital multi meter For BLM18SN_TN Measuring Equipment: YOKOGAWA 755611 or the equivalent Test Fixture: KEYSIGHT 16044A or the equivalent *Except resistance of the Substrate and Wire

7-2.Mechanical Performance

No.	Item	Specification	Test Method
7-2-1	Appearance and Dimensions	Meet item 4.	Visual Inspection and measured with Slide Calipers.
7-2-2	Bonding Strength	Meet Table 1. Table 1 Appearance No damage Impedance Within ±30% (for BLM18SN_TN (at 100MHz) Within ±50%) DC Resistance Meet item 3.	It shall be soldered on the substrate. Applying Force(F): 6.8N Applying Time: 5s±1s Applied direction: Parallel to substrate Side view Florida Substrate
7-2-3	Bending Strength		It shall be soldered on the substrate. Substrate: Glass-epoxy 100mm×40mm×1.6mm Deflection : 1.0mm Speed of Applying Force : 0.5mm/s Keeping Time : 30s Pressure jig R340 Product
7-2-4	Vibration		It shall be soldered on the substrate. Oscillation Frequency: 10Hz to 55Hz to 10Hz for 1 min Total Amplitude: 1.5mm Testing Time: A period of 2 hours in each of 3 mutually perpendicular directions. (Total 6 h)
7-2-5	Resistance to Soldering Heat	Meet Table 2. Table 2 Appearance No damage Impedance Change (at 100MHz) (for BLM18KG Within ±40%) (for BLM18SN_TN Within ±50%) DC Resistance Meet item 3.	Pre-Heating: 150°C±10°C, 60s∼90s Solder: Sn-3.0Ag-0.5Cu Solder Temperature: 270°C±5°C Immersion Time: 10s±0.5s Immersion and emersion rates: 25mm/s Then measured after exposure in the room condition for 48h±4h.

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No.	Item	Specification	Test Method
7-2-6	Drop	Products shall be no failure after	It shall be dropped on concrete or steel board.
		tested.	Method : free fall
			Height: 75cm
			Attitude from which the product is dropped: 3 direction
			The number of times: 3 times for each direction(Total 9 times)
7-2-7	Solderability	The electrodes shall be at least	Flux : Ethanol solution of rosin,25(wt)%
		95% covered with new solder	Pre-Heating : $150^{\circ}\text{C} \pm 10^{\circ}\text{C}$, $60\text{s} \sim 90\text{s}$
		coating.	Solder : Sn-3.0Ag-0.5Cu
			Solder Temperature : 240°C±5°C
			Immersion Time : 3s±1s
			Immersion and emersion rates : 25mm/s

7-3. Environmental Performance

It shall be soldered on the substrate.

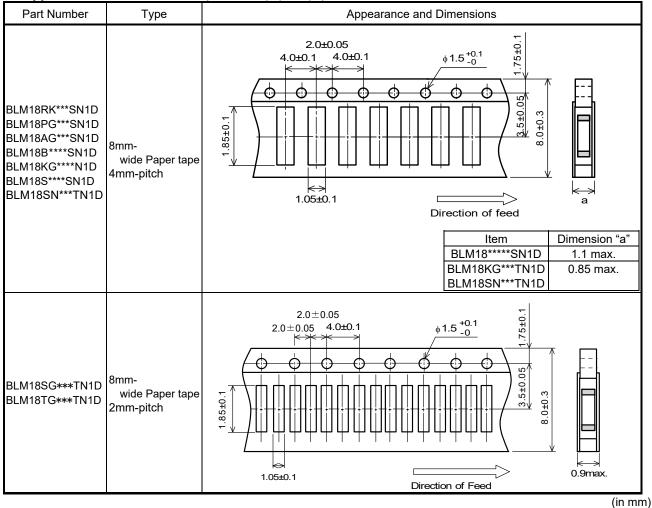
No.	Item	Specification	Test Method
	Temperature Cycle	Meet Table 3. Table 3 Appearance No damage Impedance Change (at 100MHz) Within ±30% (for BLM18KG Within-10%to+50% (for BLM18SN_TN Within ±50%) DC Resistance Meet item 3.	1 cycle: 1 step:-55 °C(+0 °C,-3 °C) / 30min±3min 2 step:Ordinary temp. / 10min to 15min 3 step:+125 °C(+3 °C,-0 °C) / 30min±3min 4 step: Ordinary temp. / 10min to 15min Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity	Meet Table 1.	Temperature: 40°C±2°C Humidity: 90%(RH) to 95%(RH) Time: 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-3	Heat Life		Temperature: 125°C±3°C (in case of Rated current is more than 1A, do the test at: +85 °C±3°C) Applying Current: Rated Current Time: 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance		Temperature : -55±2°C Time : 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

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8. Specification of Packaging

8-1.Appearance and Dimensions (8mm-wide paper tape)



(1) Taping

Products shall be packaged in the cavity of the base tape continuously and sealed by top tape and bottom tape.

- (2) Sprocket hole: The sprocket holes are to the right as the tape is pulled toward the user.
- (3) Spliced point: The base tape and top tape have no spliced point
- (4) Cavity: There shall not be burr in the cavity.
- (5) Missing components number

Missing components number within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

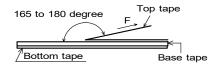
8-2. Tape Strength

(1)Pull Strength

Top tape	TNI main
Bottom tape	5N min.

(2)Peeling off force of Top tape

0.1N to 0.6N (Minimum value is typical.) *Speed of Peeling off:300mm/min



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8-3. Taping Condition

(1)Standard quantity per reel

Туре	Quantity per 180mm reel
BLM18(except BLM18SG/BLM18TG)	4000 pcs. / reel
BLM18SG/BLM18TG	10000 pcs. / reel

- (2) There shall be leader-tape (top tape and empty tape) and trailer- tape (empty tape) as follows.
- (3)On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

(4)Marking for reel

The following items shall be marked on a label and the label is stuck on the reel.

(Customer part number, MURATA part number, Inspection number(*1), RoHS Marking(*2), Quantity, etc)

*1) « Expression of Inspection No. »

 $\Box\Box$ OOOO $\times\times\times$

(1) Factory Code

(2) Date

Year / Last digit of year

First digit Second digit Month / Jan. to Sep. \rightarrow 1 to 9, Oct. to Dec. \rightarrow O, N, D

Third, Fourth digit: Day

(3) Serial No.

*2) « Expression of RoHS Marking »

ROHS $-\frac{Y}{(1)}(\underline{\Delta})$

- (1) RoHS regulation conformity parts.
- (2) MURATĂ classification number

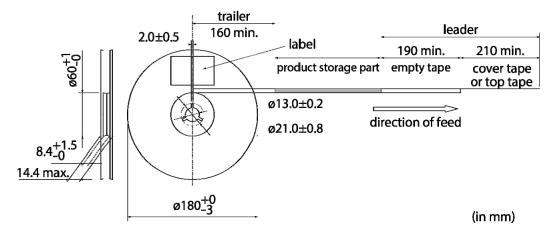
(5)Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

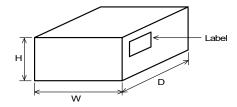
(Customer name, Purchasing order number, Customer part number, MURATA part number,

RoHS discrimination(*2), Quantity, etc)

(6)Dimensions of reel and taping(leader-tape, trailer-tape)



8-4. Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case
W	D	Н	(Reel)
186	186	93	5

^{*} Above Outer Case size is typical. It depends on a quantity of an order.

9. 🗘 Caution

9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.

Please contact us in advance in case of applying the surge current.

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9-2.Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (6) Disaster prevention / crime prevention equipment
- (2) Aerospace equipment
- (7) Traffic signal equipment
- (3) Undersea equipment
- (8) Transportation equipment (vehicles,trains,ships,etc.)
- (4) Power plant control equipment
- (9) Data-processing equipment
- (5) Medical equipment
- (10) Applications of similar complexity and /or reliability requirements to the applications listed in the above

9-3. Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.

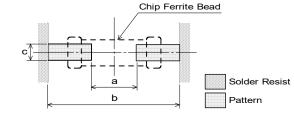
10. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

10-1.Land pattern designing

- Standard land dimensions
- < For BLM18 series (except BLM18P/BLM18S/BLM18K type) >

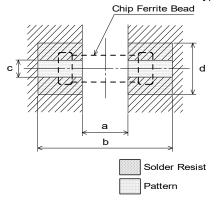


Soldering	а	b	С
Flow	8.0	2.5	0.7
Reflow	0.7	2.0	0.7
F	low	low 0.8	low 0.8 2.5

(in mm)

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< For BLM18P/BLM18S/BLM18K type >



	Rated					Land	pad thic	ckness
Type	Current	Soldering	а	b	С	and dimension d		
	(A)					18µm	35µm	70µm
DIMAGD	0.5 to 1.5	Flow/ Reflow	0.8	Flow 2.5 Reflow 2.0	0.7	0.7	0.7	0.7
BLM18P BLM18S	1.7 to 2.5					1.2	0.7	0.7
BLM18K	3 to 4					2.4	1.2	0.7
BLIVITOR	5 to 6					6.4	3.3	1.65
BLM18SN	8					-	6.4	3.3
BLM18SP	1.2 to 6.0					-	6.4	-

(in mm)

10-2. Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

''	i lux,coluc	ioi			
	Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)			
		Do not use water-soluble flux.			
	Solder	Use Sn-3.0Ag-0.5Cu solder			
		Standard thickness of solder paste : 100 μm to 200 μm			

^{*}The excessive heat by land pads may cause deterioration at joint of products with substrate.

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(2) Soldering conditions

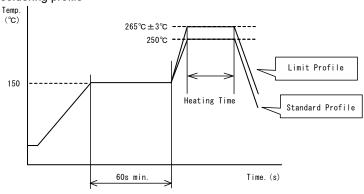
 Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

Standard soldering profile and the limit soldering profile is as follows.
 The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration of product quality.

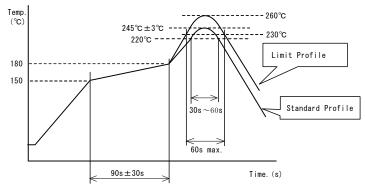
(3) soldering profile

□Flow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C、60s min.	
Heating	250°C、4∼6s	265°C±3°C、5s max.
Cycle of flow	2 times	2 times

□Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150~180°C 、90s±30s	
Heating	above 220°C、30s∼60s	above 217°C、60s~150s
Peak temperature	245±3°C	260°C,10s
Cycle of reflow	2 times	2 times

10-3. Reworking with soldering iron

Pre-heating: 150°C, 1 min
Soldering iron output: 80W max.

Tip temperature: 350°C max.
 Tip diameter: φ 3mm max.

• Soldering time : 3(+1,-0) seconds. • Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

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10-4.Solder Volume

Solder shall be used not to be exceeded as shown below.

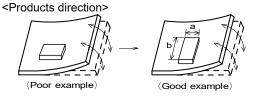


Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

10-5.Attention regarding P.C.B. bending

The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage.



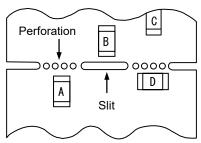
Products shall be located in the sideways direction (Length: a<b) to the mechanical stress.

(2)Components location on P.C.B. separation.

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce stress.

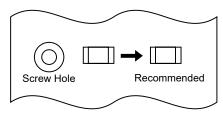
Contents of Measures	Stress Level
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1
(2) Add slits in the board separation part.	A > B
(3) Keep the mounting position of the component away from the board separation surface.	A > C



*1 A > D is valid when stress is added vertically to the perforation as with Hand Separation. If a Cutting Disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.

(3) Mounting Components Near Screw Holes

When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw. Mount the component in a position as far away from the screw holes as possible.



10-6. Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

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10-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl₂, H₂S, NH₃, SO₂, NO₂,etc)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew

10-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

10-9.Cleaning

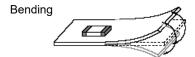
Excessive ultrasonic oscillation during cleaning can cause the PCBs to resonate, resulting in cracked chips or broken solder joints. Before starting your production process,

test your cleaning equipment / process to insure it does not degrade this product.

10-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.





10-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature: -10°C to 40°C

Humidity : 15% to 85% relative humidity
No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Avoid storing the product by itself bare (i.e. exposed directly to air).

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

11. Note

- Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- $\label{eq:continuous} \mbox{(2)You are requested not to use our product deviating from the reference specifications.}$
- (3)The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

Part Numbering

Chip Ferrite Bead

BL M 18 AG 102 S N 1 D (Part Number) 6 6 6 8 9

1Product ID

Product ID	
BL	Chip Ferrite Beads

2Type

Code	Туре
Α	Array Type
E	DC Bias Characteristics Improved Type
М	Ferrite Bead Single Type
Т	Assembly Type

4Characteristics	/Applications		
Code *1	Characteristics/Applications		
AG			
AX	For General Use		
TG			
ВА			
ВВ			
ВС	For High-speed Signal Lines		
BD			
вх			
KD			
KG			
KN			
KX			
PD			
PG			
PN			
PS	For Power Lines		
PK			
PX			
PT			
SD			
SG			
SN			
SP			
RK	For Digital Interface		
HG	For GHz Band General Use		
EB	For GHz Band High-speed Signal Lines (Low Direct Current Type)		
EG	 - For GHz Band General Use (Low DC Resistance Type)		
EX	Totalization achieva asset (2017 20 Nesistance Type)		
НВ			
HD	For GHz Band High-speed Signal Lines		
HE			
HK	For GHz Band Digital Interface		
GA	For High-GHz Band High-speed Signal Lines		
GG	For High-GHz Band General Use		
DN	For High-GHz Band General Use (Low Direct Current Type)		

 $[\]overline{{}^{*1}}$ Frequency characteristics vary with each code.

3Dimensions (LxW)

- ' ' ' ' '	,	
Code	Dimensions (LxW)	Size Code (inch)
02	0.4x0.2mm	01005
03	0.6x0.3mm	0201
15	1.0x0.5mm	0402
18	1.6x0.8mm	0603
2A	2.0x1.0mm	0804
21	2.0x1.25mm	0805
31	3.2x1.6mm	1206
32	3.2x2.5mm	1210
41	4.5x1.6mm	1806
5B	5.0x5.0mm	2020

6Impedance

Expressed by three figures. The unit is in ohm (Ω) at 100MHz. The first and second figures are significant digits, and the third figure expresses the number of zeros that follow the two figures.

6Electrode

Expressed by a letter.

Ex.)	Code	Electrode
	s	Sn Plating
	Α	Au Plating
	L	Lead-Free Solder Plating
	W	Ag/Pd

Category

Code	Category
N	For General-Purpose

8 Number of Circuits

Code	Number of Circuits
1	1 Circuit
4	4 Circuits

Packaging

Code	Packaging
K	Embossed Taping (ø330mm Reel)
L	Embossed Taping (ø180mm Reel)
В	Bulk
J	Paper Taping (ø330mm Reel)
D	Paper Taping (ø180mm Reel)